

1318123-1 ✓ ACTIVE

[Dynamic Series](#) | [Dynamic 2000 Series](#)

TE Internal #: 1318123-1

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series

[View on TE.com >](#)



Connectors > PCB Connectors > PCB Headers & Receptacles > DYNAMIC 2000 HDR ASSY



Connector System: **Wire-to-Board**

Number of Positions: **3**

Number of Rows: **1**

Centerline (Pitch): **2.5 mm [.099 in]**

PCB Mount Orientation: **Vertical**

[All DYNAMIC 2000 HDR ASSY \(44\)](#)

Features

Product Type Features

| | |
|-----------------------------------|-----------------------|
| Connector System | Wire-to-Board |
| Header Type | Fully Shrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |

Configuration Features

| | |
|-----------------------|----------|
| Number of Positions | 3 |
| Number of Rows | 1 |
| PCB Mount Orientation | Vertical |

Body Features

| | |
|-----------------------|-------|
| Primary Product Color | Black |
|-----------------------|-------|

Contact Features

| | |
|--|--------------------------|
| Contact Mating Area Plating Material Thickness | .38 μ m[15 μ in] |
| Contact Mating Area Plating Material | Gold |
| Contact Type | Pin |
| Contact Current Rating (Max) | 5 A |



Termination Features

| | |
|---|-----------------------|
| Termination Method to Printed Circuit Board | Through Hole - Solder |
|---|-----------------------|

Mechanical Attachment

| | |
|--------------------------|---------------|
| Mating Alignment Type | Keyed |
| Mating Retention | With |
| PCB Mount Retention Type | Retention Leg |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | With |

Housing Features

| | |
|--------------------|------------------|
| Housing Material | Polyester GF |
| Centerline (Pitch) | 2.5 mm [.099 in] |

Usage Conditions

| | |
|-----------------------------|-----------------------------|
| Operating Temperature Range | -55 – 105 °C [-67 – 221 °F] |
|-----------------------------|-----------------------------|

Operation/Application

| | |
|---------------------|----------------|
| Circuit Application | Power & Signal |
|---------------------|----------------|

Industry Standards

| | |
|------------------------|----------|
| UL Flammability Rating | UL 94V-0 |
|------------------------|----------|

Packaging Features

| | |
|----------------|-----------|
| Packaging Type | Box, Tube |
|----------------|-----------|

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

| | |
|---|---|
| EU RoHS Directive 2011/65/EU | Compliant |
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 |

ppm.

Solder Process Capability

Wave solder capable to 265°C

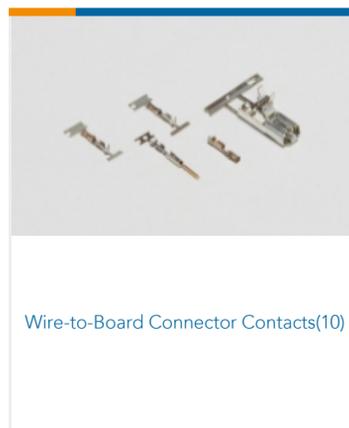
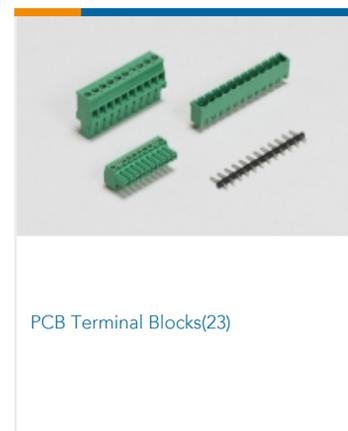
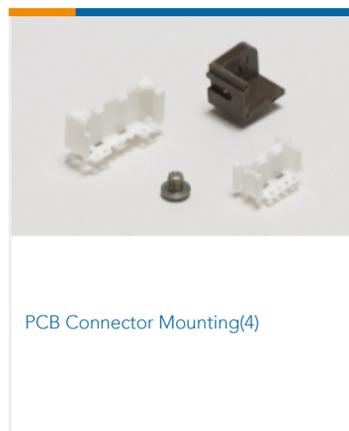
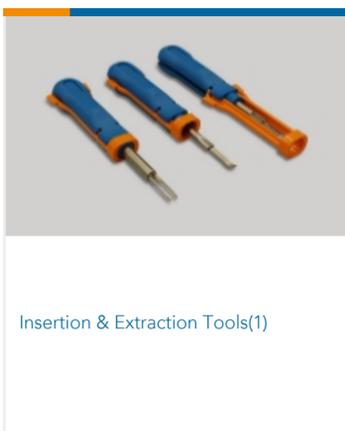
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Also in the Series | Dynamic 2000 Series



Documents



Product Drawings

DYNAMIC D2100 HDR V ASSY 3P

Japanese

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_1318123-1_D.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1318123-1_D.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1318123-1_D.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

1-1773721-5_DYNAMIC_SERIES_QRG

English

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Dynamic Connector D-2000 Series

Japanese

Application Specification

Japanese

Product Environmental Compliance

MD_1318123-1_091820181437_dmtec

English

MD_1318123-1_091820181437_dmtec

English

Agency Approvals

Agency Approval Document

English